



Click here for the 3D model.

D 8mm +/-0.5mm L 6.2mm +/-0.3mm W 0.65mm +/-0.1mm F 0.3mm MAX A 8.3mm +/-0.2mm B 8.3mm +/-0.2mm C 9.5mm MAX	
W 0.65mm +/-0.1mm F 0.3mm MAX A 8.3mm +/-0.2mm B 8.3mm +/-0.2mm C 9.5mm MAX	
F 0.3mm MAX A 8.3mm +/-0.2mm B 8.3mm +/-0.2mm C 9.5mm MAX	
A 8.3mm +/-0.2mm B 8.3mm +/-0.2mm C 9.5mm MAX	
B 8.3mm +/-0.2mm C 9.5mm MAX	
C 9.5mm MAX	
5 04 1/00	
E 3.4mm +/-0.2mm	
G 0.35mm +0.15/-0.2mm	
P 2.2mm +/-0.2mm	

Packaging Specifications	
Packaging	T&R
Packaging Quantity	1000

General Information	
Series	EDT
Dielectric	Aluminum Electrolytic
Style	SMD Can
Description	Surface Mount, Aluminum Electrolytic
RoHS	Yes
Lead	V-Chip
Qualifications	AEC-Q200
AEC-Q200	Yes

Specifications	
Capacitance	100 uF
Capacitance Tolerance	20%
Voltage DC	25 VDC, 32 VDC (Surge)
Temperature Range	-40/+125°C
Rated Temperature	125°C
Life	1000 Hrs
Dissipation Factor	18%
Ripple Current	75 mAmps (120Hz 125C)
Leakage Current	25 uA (2min 20°C)
Impedance Ratio at -25C	2
Impedance Ratio at -40C	3
High Temperature Solder	Yes

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